



Readout Status

Zeeshan Ahmed

CMB-S4 Collaboration Meeting
May 9-13, 2022



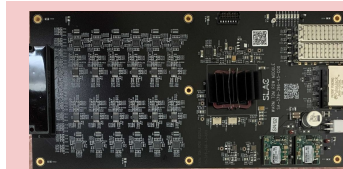
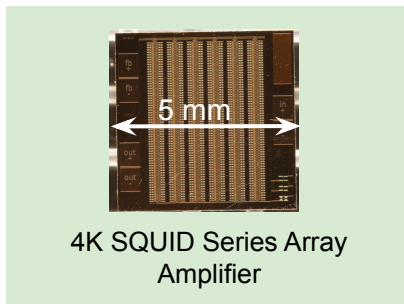
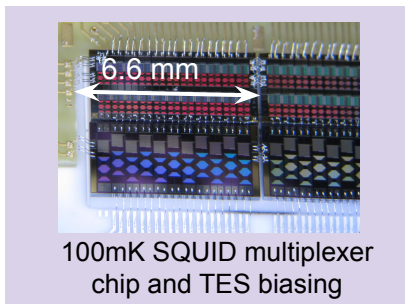
Outline

- Overview of Readout Scope
- Technical Highlights / Progress made in the last year
- Plans through FY22

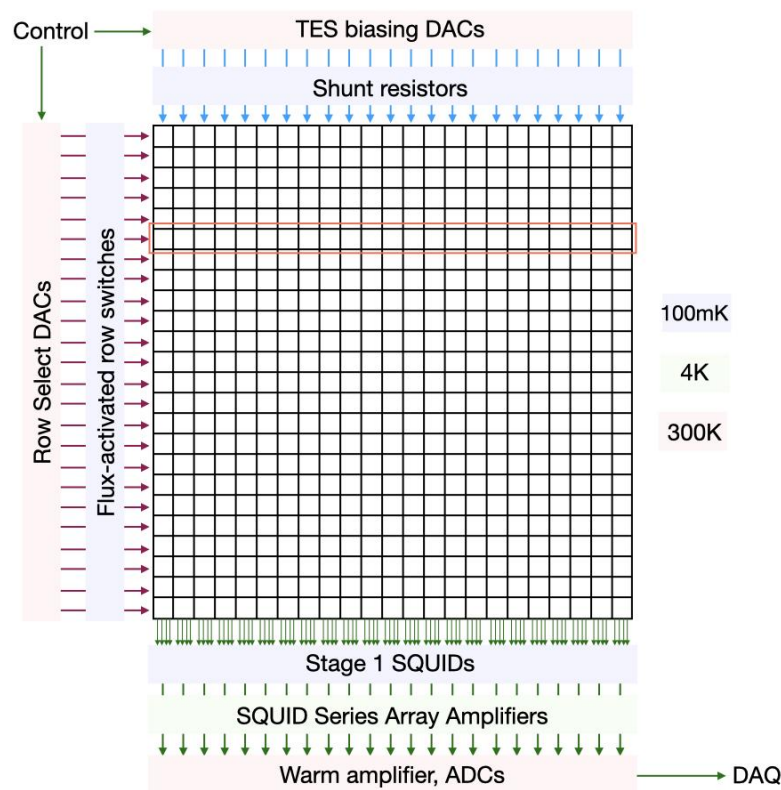
System Design: Time-Division Multiplexing

- Arrange TESes of a detector wafer as a 2D logical grid
- Read one “row” at a time; switch at ~10s of kHz
- Connections to 300K scale as perimeter, not as area
- CMB-S4 will use ~80 “rows” (MUX80)

Superconducting Quantum Interference Devices (SQUIDs) used as cryogenic amplifiers and as row multiplexer.



Room temperature electronics are low-frequency boards with low-noise precision ADCs and DACs.

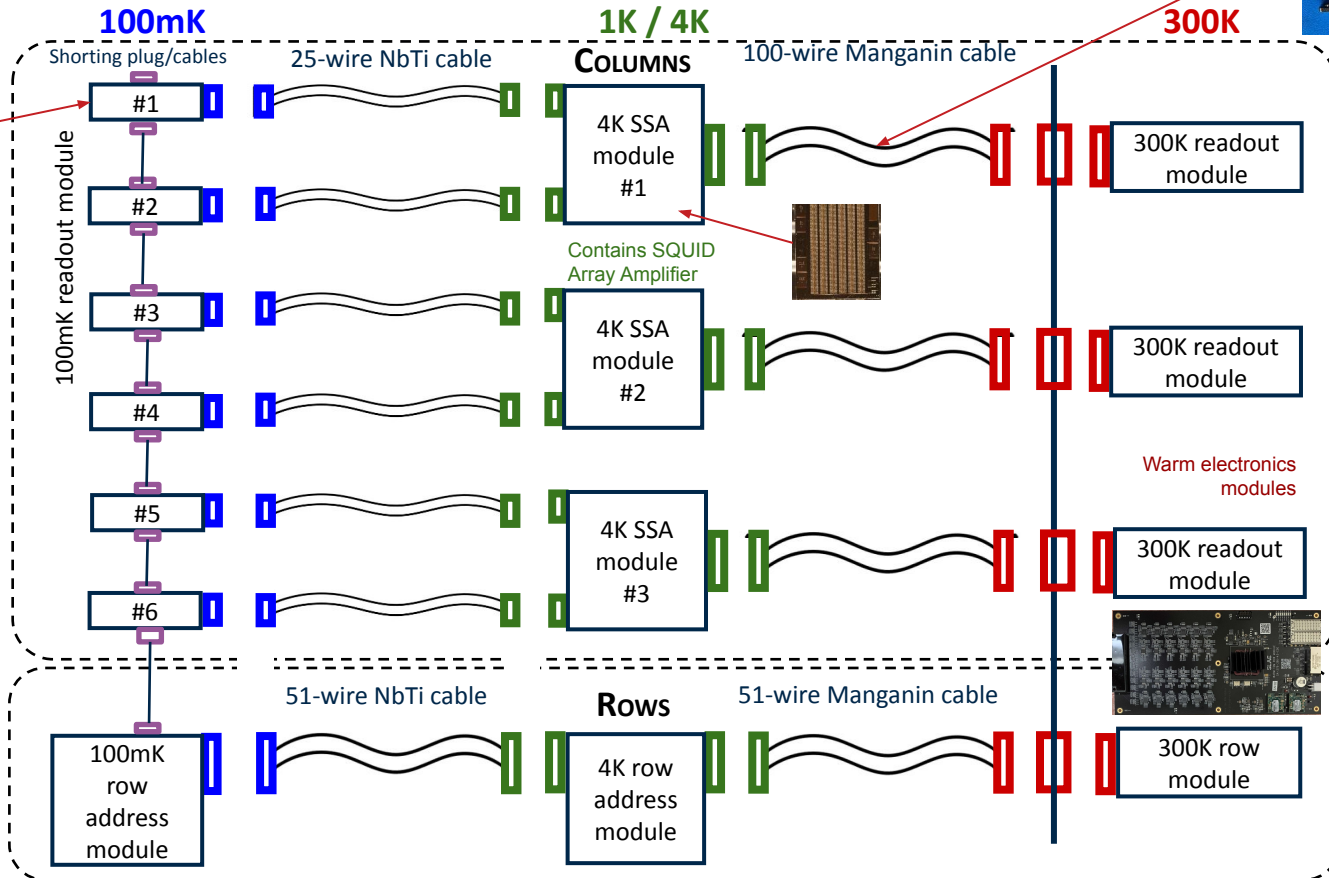
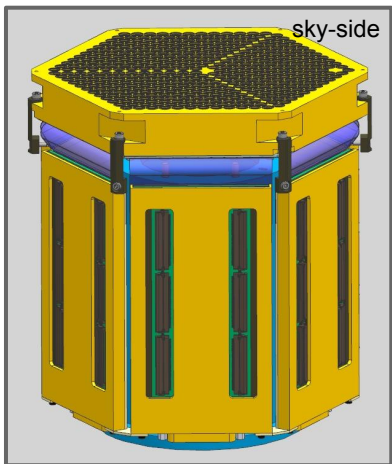


System Design: Modularity Built Into Form Factor

100mK readout module contains SQUID multiplexer and TES bias chips



80 rows x 4 col x 6 sides of hex = 1920 channels



Cryogenic cabling

Readout Prototyping: Develop, Build And Test End-To-End Strings For Design Validation

Contains SQUID multiplexer and TES bias chips



100mK

1K / 4K

300K

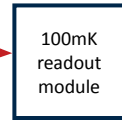
COLUMNS

Vacuum

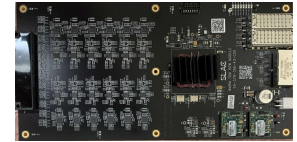
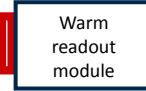
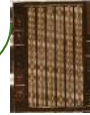
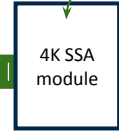
Air

Start with MCE crates, upgrade with new warm modules.

100mK readout module



Contains SQUID Series Array Amplifier

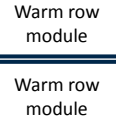
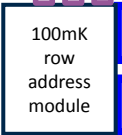


100mK row address module

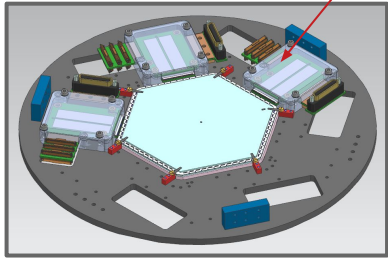
Rows

100-wire NbTi cable

100-wire Manganin cable

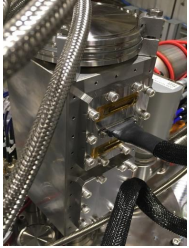


Cryogenic cabling



Prototype test setup with 100mK readout modules mounted horizontally with detector module

Significant Progress In R&D: Built Out Standardized Prototype Hardware For Readout And Detector Testbeds



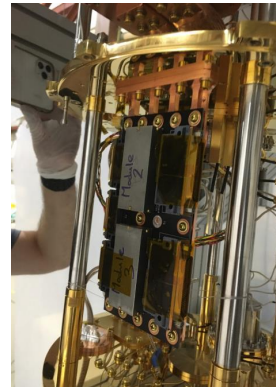
300K Vacuum Feedthroughs and connectors



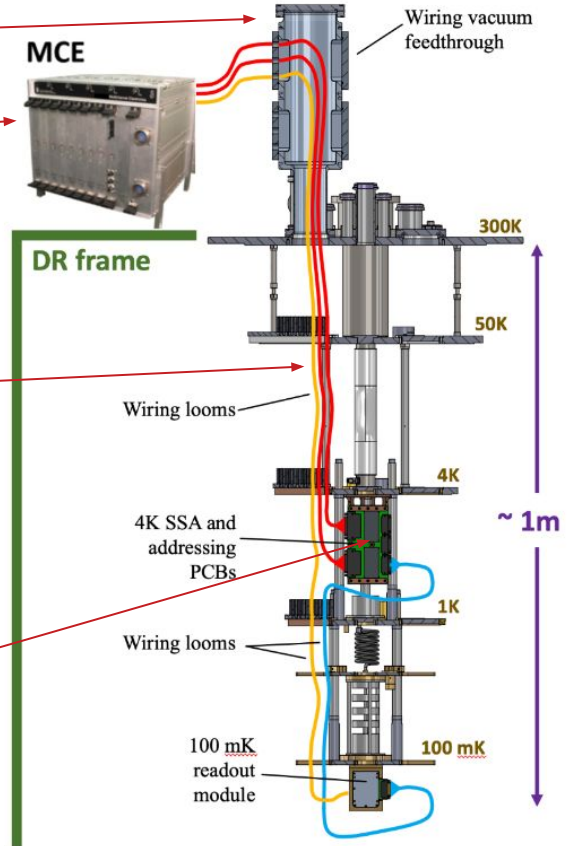
MCE readout electronics built by UBC used in prototyping and to start test stands



300K-to-4K and 4K-to-100mK cabling and heatsinks

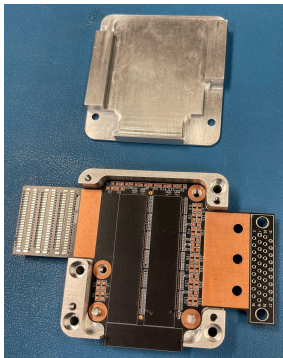


4K SSA amplifier board



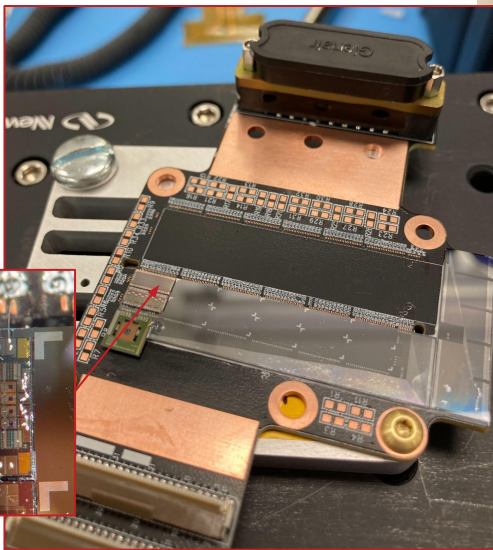
Significant Progress In R&D: 100mK Readout Proto Module Designed and Fabricated

RO test stand at SLAC

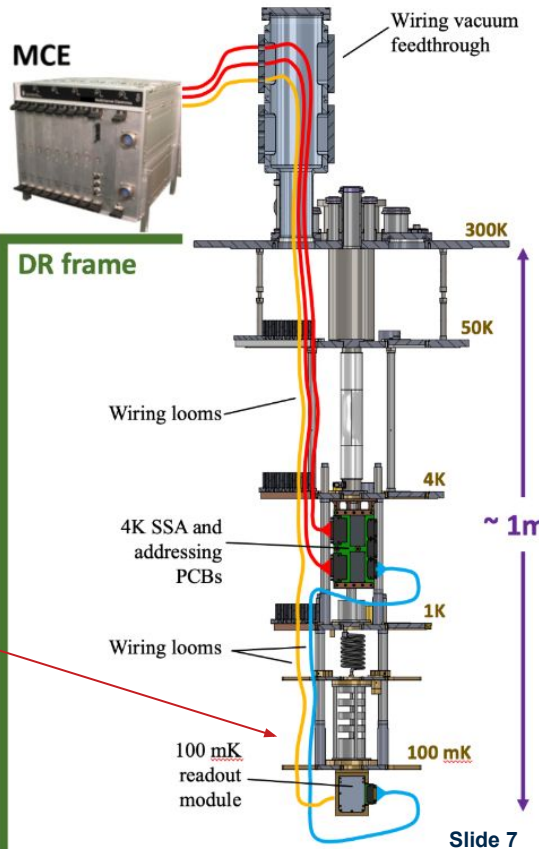
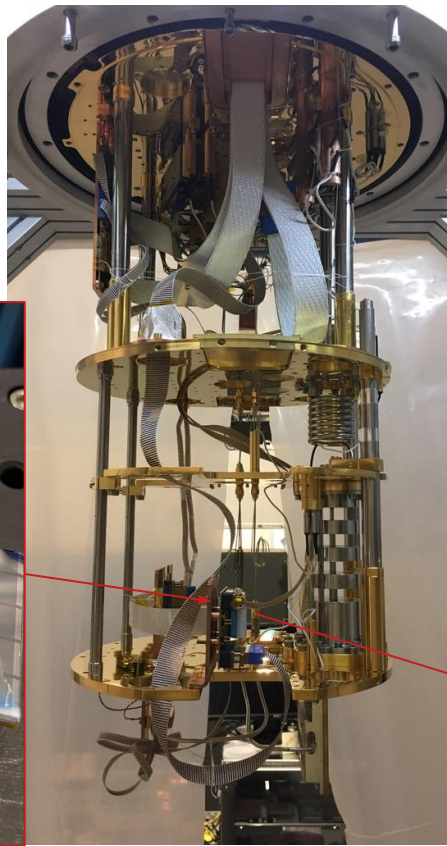
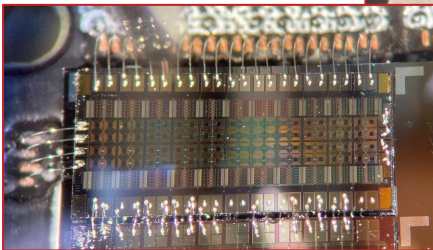


100mK RO module with magnetically-shielded enclosure

100mK RO board



NIST TDM 100mK MUX chip



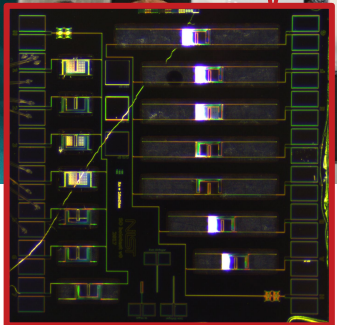
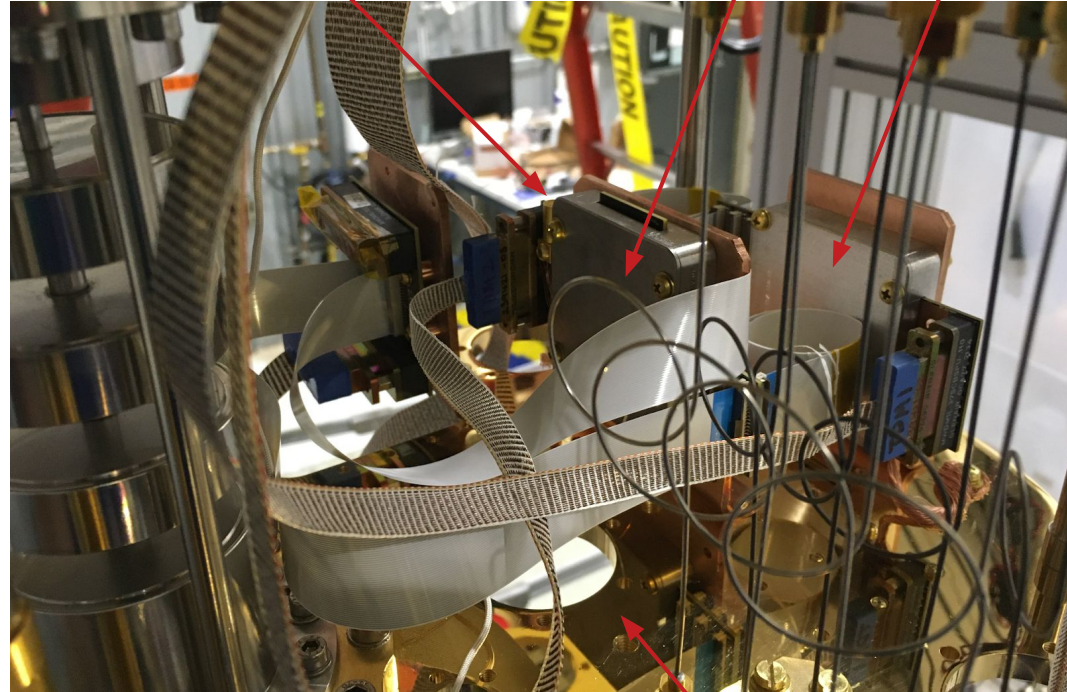
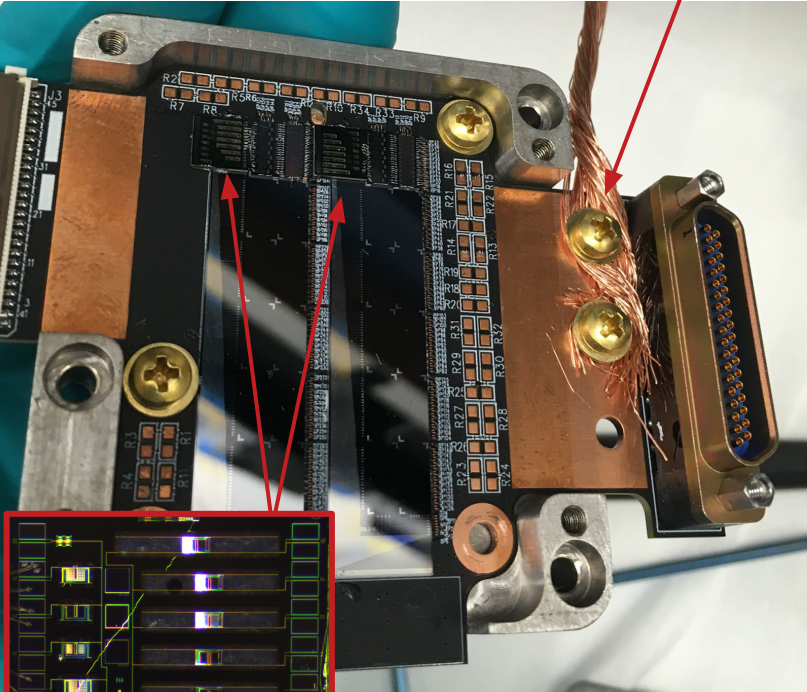
Significant Progress In R&D: Full-String Tests With 100mK Readout Module

OFHC copper straps on PCBs

ROX on PCB

Nb module

Al module



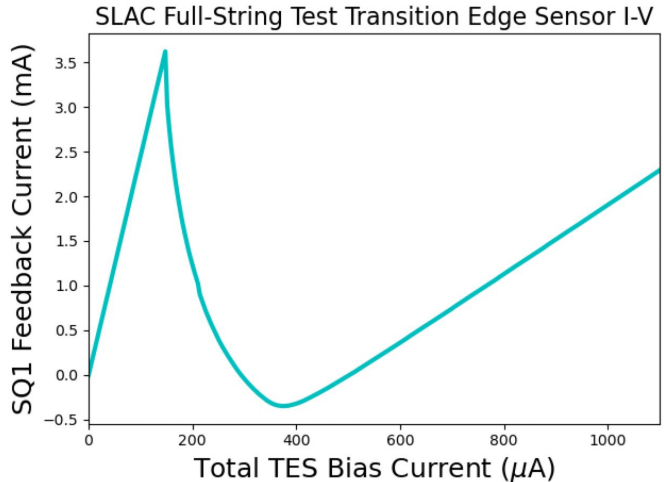
NIST TES bolometer chips bonded directly to inputs: many 27, 90, 150, 280 GHz devices

SLAC DR 100mK MXC plate

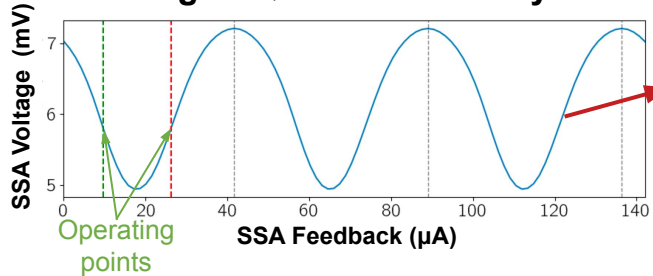
Full-String Test Results With 100mK Readout Module: SQUID Tuning And TES Biasing Into Transition

100% readout channel yield for first two 100mK readout modules after rework.

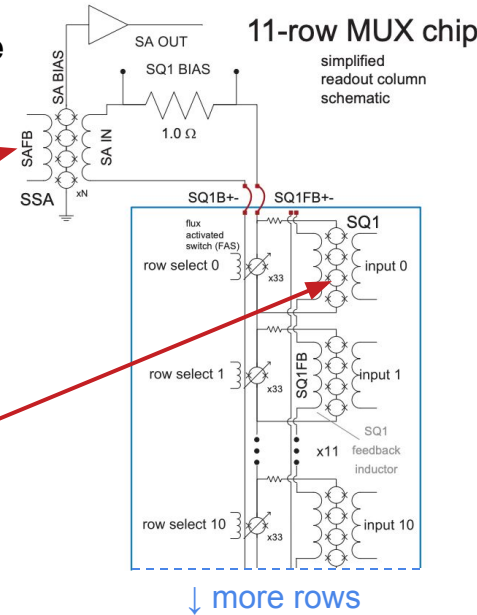
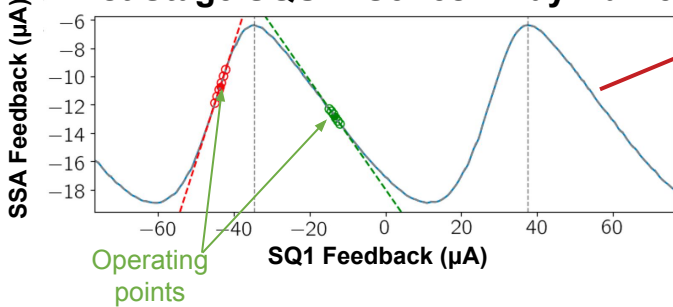
Measured SQUID performance matches NIST screening data.



2nd Stage SQUID Series Array Curve



1st Stage SQUID Series Array Curve



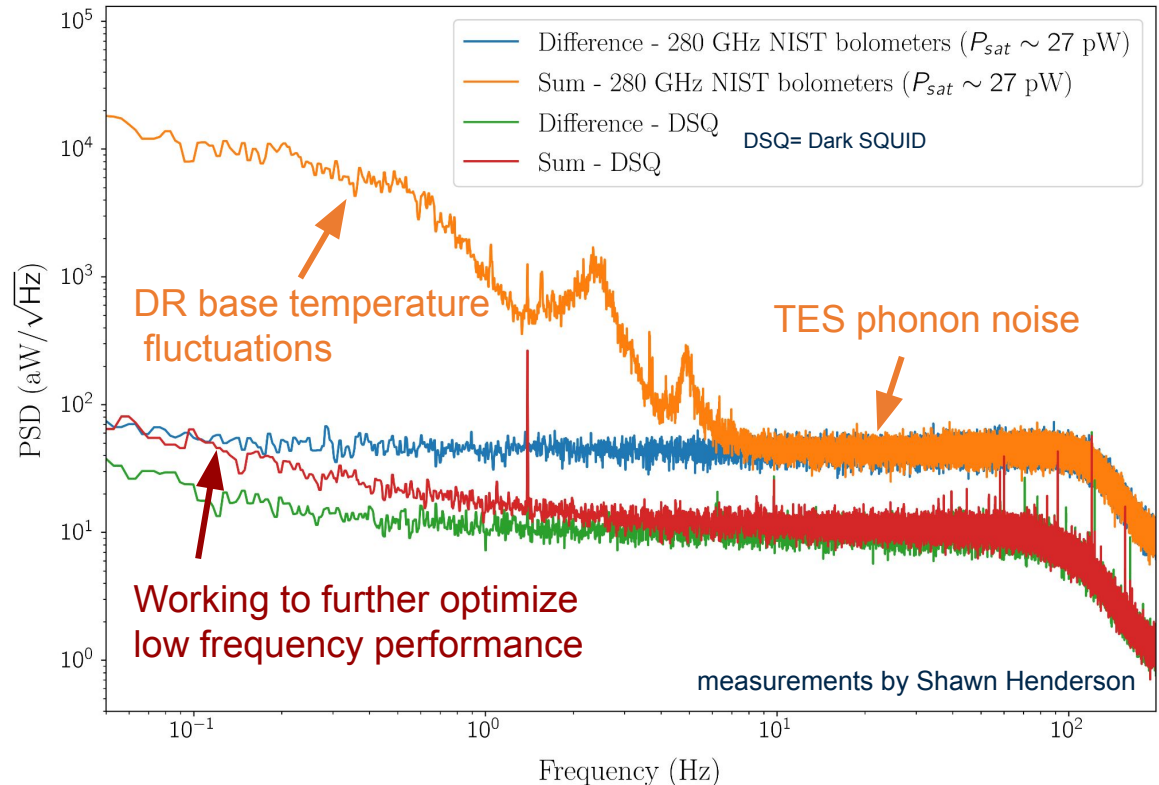
Able to recover signals injected into SQ1 inputs, take TES current vs voltage characterization data (IVs) and bias TESs into transition.

Installation and measurements by Shawn Henderson.

Full-String Test Results With 100mK Readout Module: Characterized TES+SQUID noise performance

- End-to-end characterization in progress with TESs connected to readout.
 - Readout performance consistent with expectations.
 - Developing end-to-end readout + TES model.
- Using test TES bolometers, able to explore performance over full range of CMB-S4 TES P_{sat} (30-280 GHz optimized devices).
 - Characterizing pairs of NIST TES test devices.

SLAC Readout String Test with NIST Bolometers



Backup